

A

B

C

D

E

版次	ECN 编码	描述		设计/日期
1	EL24060016	初版发行		江蒙_2024/06/01
		改前	改后	

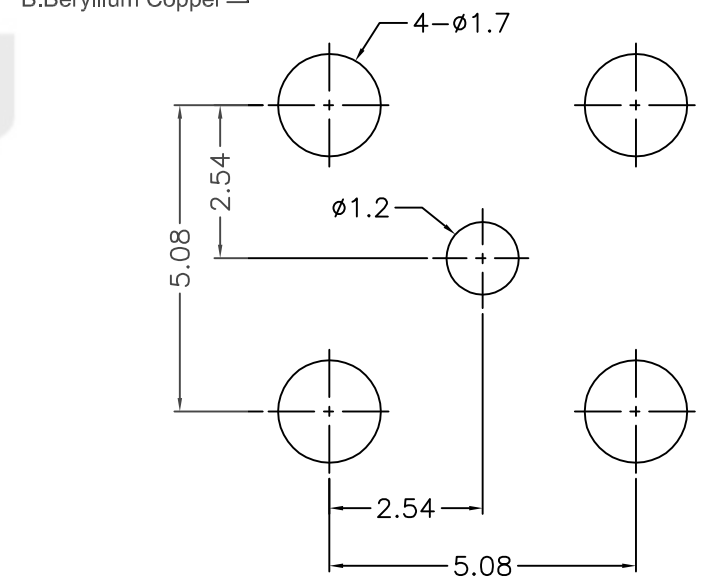
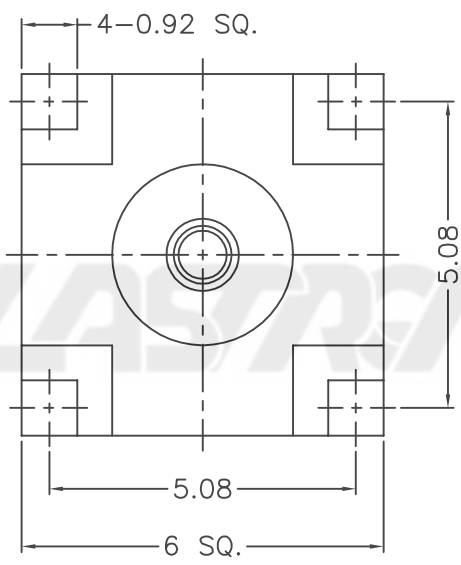
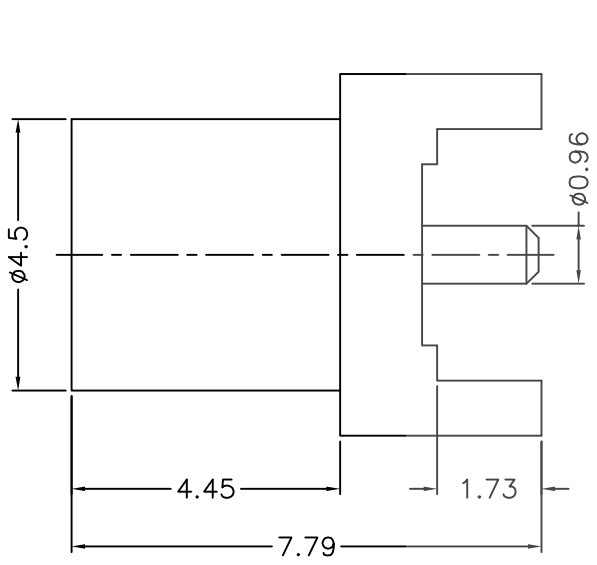
NOTES: FINISH(PLATING THICKNESS IN MICRO-INCHES)

- BRASS
- THIN GOLD OVER NICKEL PL.50 MIN.THICK OVER COPPER PL.50 MIN.THICK
- BERYLLIUM COPPER
- GOLD PL.3 MIN.THICK OVER NICKEL PL.50 MIN.THICK OVER COPPER PL.50 MIN.THICK
- TEFLON

JFCKBGBXX

F:RF
C:超小型
K:MCX
B:Beryllium Copper

A: Gold Flash
D:3u"
G:10u"
L:30u"
B:Gold Plating



RoHS COMPLIANT

RECOMMENDED PCB LAYOUT



TOLERANCE TABLE		SCALE	DRAWN	DATE	DWG. NO.	TITLE	REV.
X. ± 0.30	X.° ± 3°	2.5:1	江蒙	2024/06/01	600-0000-2461	MCX P.C. BOARD RECEPT. JACK CUSTOMER DRAWING	1
.X ± 0.25	.X° ± 2°	UNIT mm	李晨涛	2024/06/01			PARTS NO.(INTENDED USE)
.XX ± 0.20		SIZE A4	朱宁静	2024/06/01	JFCKBGBXX		1/1

A

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